Renesas Electronics America Inc - R5F51137ADFM#3A Datasheet

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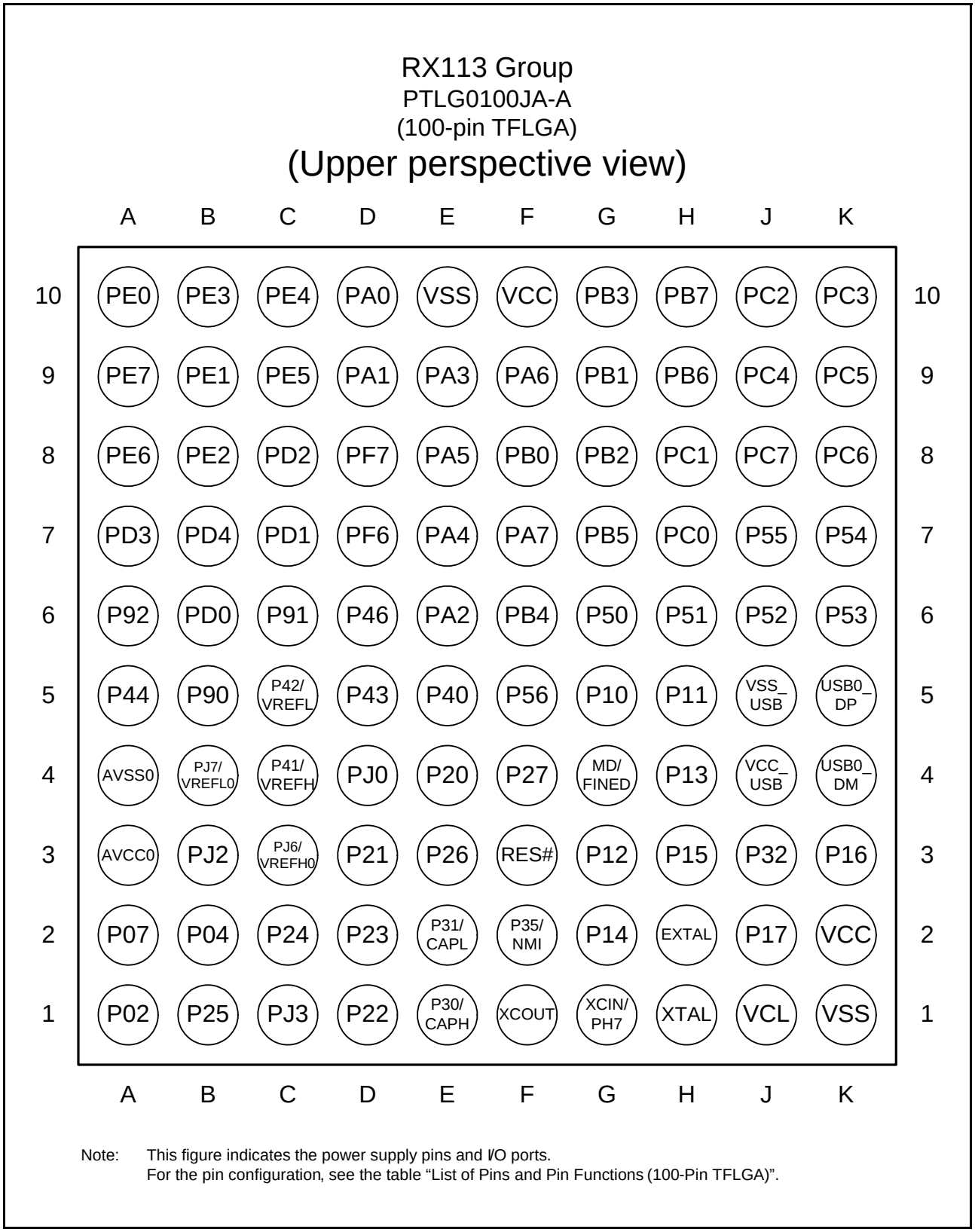
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I²C, IrDA, SCI, SPI, SSI, USB OTG
Peripherals	DMA, LCD, LVD, POR, PWM, WDT
Number of I/O	44
Program Memory Size	384KB (384K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 11x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51137adfm-3a

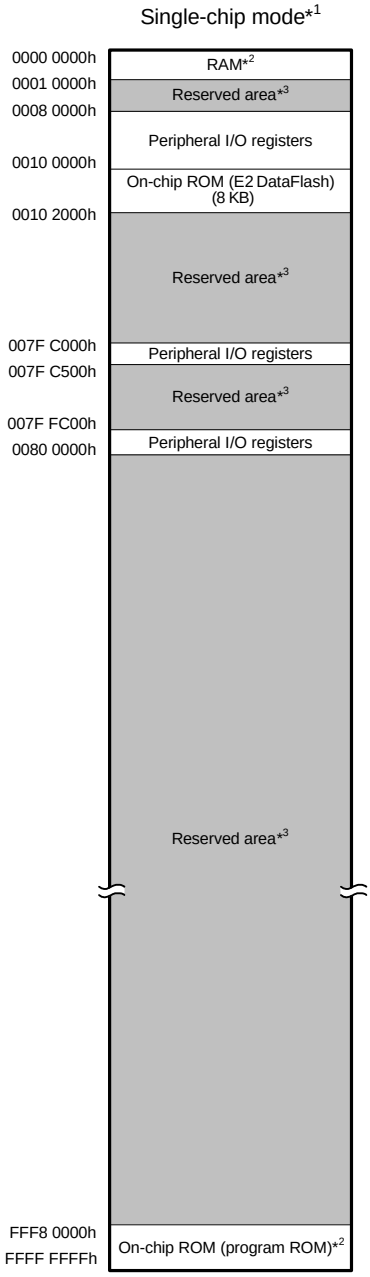


Note: This figure indicates the power supply pins and I/O ports.
For the pin configuration, see the table “List of Pins and Pin Functions (100-Pin TFLGA)”.

Figure 1.4 Pin Assignments of the 100-Pin TFLGA

Table 1.5 List of Pins and Pin Functions (100-Pin LFQFP) (1/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC, TMR)	Communication (SCIe, SCIf, RSPI, RIIC, USB, SSI)	LCD, Touch	Others
1		P04	MTIOC0A/POE2#/TMCI3	SCK6	TS1	
2		PJ0				DA0
3		P02	MTIOC0D/POE3#/TMRI3	RXD6/SMISO6/SSCL6	TS2	
4		PJ3	MTIOC3C	CTS6#/RTS6#/SS6#	TS3	
5		P25	MTIOC4C/MTCLKB		TS4	ADTRG0#
6		P24	MTIOC4A/MTCLKA/ TMRI1		TS5	
7		P23	MTIOC3D/MTCLKD	CTS0#/RTS0#/SS0#	TS6	
8		P22	MTIOC3B/MTCLKC/ TMO0	SCK0	TS7	
9		P21	MTIOC1B/TMCI0	RXD0/SMISO0/SSCL0	TS8	
10		P20	MTIOC1A/TMRI0	TXD0/SMOSI0/SSDA0	TS9	
11		P27	MTIOC2B/TMCI3	SCK12/SCK1/RXD6/SMISO6/ SSCL6	TS10	IRQ3/ADTRG0#/ CACREF/ CMPA2
12		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ USB0_VBUSEN/TXD6/SMOSI6/ SSDA6	TSCAP	
13		P30	MTIOC4B/POE8#/TMRI3	RXD1/SMISO1/SSCL1	CAPH	IRQ0
14		P31	MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#	CAPL	IRQ1
15	MD					FINED
16	RES#					
17	XCOUT					
18	XCIN	PH7				
19	UPSEL	P35				NMI
20	XTAL					
21	EXTAL					
22	VCL					
23	VSS					
24	VDD					
25		P32	MTIOC0C/RTCOUT/ TMO3	TXD6/SMOSI6/SSDA6/CTS6#/ RTS6#/SS6#	TS11	IRQ2
26		P17	MTIOC0C/MTIOC3A/ MTIOC3B/POE8#/TMO1	SCK1/MISOA/SDA0/RXD12/ RXDX12/SMISO12/SSCL12		IRQ7
27		P16	MTIOC3C/MTIOC3D/ RTCOUT/TMO2	TXD1/SMOSI1/SSDA1/MOSIA/ SCL0/USB0_VBUS/ USB0_VBUSEN/USB0_OVRCURB		IRQ6/ADTRG0#
28		P15	MTIOC0B/MTCLKB/ TMCI2	RXD1/SMISO1/SSCL1/RSPCKA		IRQ5/CLKOUT/ CACREF
29	UB#	P14	MTIOC0A/MTIOC3A/ MTCLKA/TMRI2	CTS1#/RTS1#/SS1#/SSLA0/ TXD12/TXDX12/SIOX12/SMOSI12/ SSDA12/USB0_OVRCURA		IRQ4
30	VCC_USB					
31				USB0_DM		
32				USB0_DP		
33	VSS_USB					
34		P13	MTIOC0B/TMO3	CTS12#/RTS12#/SS12#/CTS0#/ RTS0#/SS0#	SEG00	IRQ3
35		P12	TMCI1	SCK12/SCK0	SEG01	IRQ2



Note 1. The address space in boot mode is the same as the address space in single-chip mode.
Note 2. The capacity of ROM/RAM differs depending on the products.

ROM (bytes)		RAM (bytes)	
Capacity	**Address**	**Capacity**	**Address**
512 K	FFF8 0000h to FFFF FFFFh	64 K	0000 0000h to 0000 FFFFh
384 K	FFFA 0000h to FFFF FFFFh		
256 K	FFFC 0000h to FFFF FFFFh	32 K	0000 0000h to 0000 7FFFh
128 K	FFFE 0000h to FFFF FFFFh		

Note: See Table 1.3, List of Products, for the product type name.

Note 3. Reserved areas should not be accessed.

Figure 3.1 Memory Map

Table 4.1 List of I/O Registers (Address Order) (11/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 8722h	MTU0	Timer General Register F	TGRF	16	16	2 or 3 PCLKB
0008 8724h	MTU0	Timer Interrupt Enable Register 2	TIER2	8	8	2 or 3 PCLKB
0008 8726h	MTU0	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKB
0008 8780h	MTU1	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8781h	MTU1	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8782h	MTU1	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKB
0008 8784h	MTU1	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 8785h	MTU1	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 8786h	MTU1	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8788h	MTU1	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 878Ah	MTU1	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 8790h	MTU1	Timer Input Capture Control Register	TICCR	8	8	2 or 3 PCLKB
0008 8800h	MTU2	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8801h	MTU2	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8802h	MTU2	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKB
0008 8804h	MTU2	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 8805h	MTU2	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 8806h	MTU2	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8808h	MTU2	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 880Ah	MTU2	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 8880h	MTU5	Timer Counter U	TCNTU	16	16	2 or 3 PCLKB
0008 8882h	MTU5	Timer General Register U	TGRU	16	16	2 or 3 PCLKB
0008 8884h	MTU5	Timer Control Register U	TCRU	8	8	2 or 3 PCLKB
0008 8886h	MTU5	Timer I/O Control Register U	TIORU	8	8	2 or 3 PCLKB
0008 8890h	MTU5	Timer Counter V	TCNTV	16	16	2 or 3 PCLKB
0008 8892h	MTU5	Timer General Register V	TGRV	16	16	2 or 3 PCLKB
0008 8894h	MTU5	Timer Control Register V	TCRV	8	8	2 or 3 PCLKB
0008 8896h	MTU5	Timer I/O Control Register V	TIORV	8	8	2 or 3 PCLKB
0008 88A0h	MTU5	Timer Counter W	TCNTW	16	16	2 or 3 PCLKB
0008 88A2h	MTU5	Timer General Register W	TGRW	16	16	2 or 3 PCLKB
0008 88A4h	MTU5	Timer Control Register W	TCRW	8	8	2 or 3 PCLKB
0008 88A6h	MTU5	Timer I/O Control Register W	TIORW	8	8	2 or 3 PCLKB
0008 88B2h	MTU5	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 88B4h	MTU5	Timer Start Register	TSTR	8	8	2 or 3 PCLKB
0008 88B6h	MTU5	Timer Compare Match Clear Register	TCNTCMPCLR	8	8	2 or 3 PCLKB
0008 8900h	POE	Input Level Control/Status Register 1	ICSR1	16	8, 16	2 or 3 PCLKB
0008 8902h	POE	Output Level Control/Status Register 1	OCSR1	16	8, 16	2 or 3 PCLKB
0008 8908h	POE	Input Level Control/Status Register 2	ICSR2	16	8, 16	2 or 3 PCLKB
0008 890Ah	POE	Software Port Output Enable Register	SPOER	8	8	2 or 3 PCLKB
0008 890Bh	POE	Port Output Enable Control Register 1	POECR1	8	8	2 or 3 PCLKB
0008 890Ch	POE	Port Output Enable Control Register 2	POECR2	8	8	2 or 3 PCLKB
0008 890Eh	POE	Input Level Control/Status Register 3	ICSR3	16	8, 16	2 or 3 PCLKB
0008 9000h	S12AD	A/D Control Register	ADCSR	16	16	2 or 3 PCLKB
0008 9004h	S12AD	A/D Channel Select Register A	ADANSA	16	16	2 or 3 PCLKB
0008 9006h	S12AD	A/D Channel Select Register A1	ADANSA1	16	16	2 or 3 PCLKB
0008 9008h	S12AD	A/D-Converted Value Addition Mode Select Register	ADADS	16	16	2 or 3 PCLKB
0008 900Ah	S12AD	A/D-Converted Value Addition Mode Select Register 1	ADADS1	16	16	2 or 3 PCLKB
0008 900Ch	S12AD	A/D-Converted Value Addition Count Select Register	ADADC	8	8	2 or 3 PCLKB
0008 900Eh	S12AD	A/D Control Extended Register	ADCER	16	16	2 or 3 PCLKB
0008 9010h	S12AD	A/D Start Trigger Select Register	ADSTRGR	16	16	2 or 3 PCLKB
0008 9012h	S12AD	A/D Converted Extended Input Control Register	ADEXICR	16	16	2 or 3 PCLKB
0008 9014h	S12AD	A/D Channel Select Register B	ADANSB	16	16	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (15/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 B10Bh	ELC	Event Link Setting Register 10	ELSR10	8	8	2 or 3 PCLKB
0008 B10Dh	ELC	Event Link Setting Register 12	ELSR12	8	8	2 or 3 PCLKB
0008 B10Fh	ELC	Event Link Setting Register 14	ELSR14	8	8	2 or 3 PCLKB
0008 B110h	ELC	Event Link Setting Register 15	ELSR15	8	8	2 or 3 PCLKB
0008 B112h	ELC	Event Link Setting Register 17	ELSR17	8	8	2 or 3 PCLKB
0008 B113h	ELC	Event Link Setting Register 18	ELSR18	8	8	2 or 3 PCLKB
0008 B114h	ELC	Event Link Setting Register 19	ELSR19	8	8	2 or 3 PCLKB
0008 B115h	ELC	Event Link Setting Register 20	ELSR20	8	8	2 or 3 PCLKB
0008 B117h	ELC	Event Link Setting Register 22	ELSR22	8	8	2 or 3 PCLKB
0008 B119h	ELC	Event Link Setting Register 24	ELSR24	8	8	2 or 3 PCLKB
0008 B11Ah	ELC	Event Link Setting Register 25	ELSR25	8	8	2 or 3 PCLKB
0008 B11Fh	ELC	Event Link Option Setting Register A	ELOPA	8	8	2 or 3 PCLKB
0008 B120h	ELC	Event Link Option Setting Register B	ELOPB	8	8	2 or 3 PCLKB
0008 B121h	ELC	Event Link Option Setting Register C	ELOPC	8	8	2 or 3 PCLKB
0008 B122h	ELC	Event Link Option Setting Register D	ELOPD	8	8	2 or 3 PCLKB
0008 B123h	ELC	Port Group Setting Register 1	PGR1	8	8	2 or 3 PCLKB
0008 B125h	ELC	Port Group Control Register 1	PGC1	8	8	2 or 3 PCLKB
0008 B127h	ELC	Port Buffer Register 1	PDBF1	8	8	2 or 3 PCLKB
0008 B129h	ELC	Event Link Port Setting Register 0	PEL0	8	8	2 or 3 PCLKB
0008 B12Ah	ELC	Event Link Port Setting Register 1	PEL1	8	8	2 or 3 PCLKB
0008 B12Dh	ELC	Event Link Software Event Generation Register	ELSEGR	8	8	2 or 3 PCLKB
0008 B300h	SCI12	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 B301h	SCI12	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 B302h	SCI12	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 B303h	SCI12	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 B304h	SCI12	Serial Status Register	SSR	8	8	2 or 3 PCLKB
0008 B305h	SCI12	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 B306h	SCI12	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 B307h	SCI12	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 B308h	SCI12	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 B309h	SCI12	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 B30Ah	SCI12	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 B30Bh	SCI12	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 B30Ch	SCI12	I^2C Status Register	SISR	8	8	2 or 3 PCLKB
0008 B30Dh	SCI12	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 B320h	SCI12	Extended Serial Mode Enable Register	ESMER	8	8	2 or 3 PCLKB
0008 B321h	SCI12	Control Register 0	CR0	8	8	2 or 3 PCLKB
0008 B322h	SCI12	Control Register 1	CR1	8	8	2 or 3 PCLKB
0008 B323h	SCI12	Control Register 2	CR2	8	8	2 or 3 PCLKB
0008 B324h	SCI12	Control Register 3	CR3	8	8	2 or 3 PCLKB
0008 B325h	SCI12	Port Control Register	PCR	8	8	2 or 3 PCLKB
0008 B326h	SCI12	Interrupt Control Register	ICR	8	8	2 or 3 PCLKB
0008 B327h	SCI12	Status Register	STR	8	8	2 or 3 PCLKB
0008 B328h	SCI12	Status Clear Register	STCR	8	8	2 or 3 PCLKB
0008 B329h	SCI12	Control Field 0 Data Register	CF0DR	8	8	2 or 3 PCLKB
0008 B32Ah	SCI12	Control Field 0 Compare Enable Register	CF0CR	8	8	2 or 3 PCLKB
0008 B32Bh	SCI12	Control Field 0 Receive Data Register	CF0RR	8	8	2 or 3 PCLKB
0008 B32Ch	SCI12	Primary Control Field 1 Data Register	PCF1DR	8	8	2 or 3 PCLKB
0008 B32Dh	SCI12	Secondary Control Field 1 Data Register	SCF1DR	8	8	2 or 3 PCLKB
0008 B32Eh	SCI12	Control Field 1 Compare Enable Register	CF1CR	8	8	2 or 3 PCLKB
0008 B32Fh	SCI12	Control Field 1 Receive Data Register	CF1RR	8	8	2 or 3 PCLKB
0008 B330h	SCI12	Timer Control Register	TCR	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (21/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
000A 0036h	USB0	BRDY Interrupt Enable Register	BRDYENB	16	16	9 PCLKB or more
000A 0038h	USB0	NRDY Interrupt Enable Register	NRDYENB	16	16	9 PCLKB or more
000A 003Ah	USB0	BEMP Interrupt Enable Register	BEMPENB	16	16	9 PCLKB or more
000A 003Ch	USB0	SOF Output Configuration Register	SOFCFG	16	16	9 PCLKB or more
000A 0040h	USB0	Interrupt Status Register 0	INTSTS0	16	16	9 PCLKB or more
000A 0042h	USB0	Interrupt Status Register 1	INTSTS1	16	16	9 PCLKB or more
000A 0046h	USB0	BRDY Interrupt Status Register	BRDYSTS	16	16	9 PCLKB or more
000A 0048h	USB0	NRDY Interrupt Status Register	NRDYSTS	16	16	9 PCLKB or more
000A 004Ah	USB0	BEMP Interrupt Status Register	BEMPSTS	16	16	9 PCLKB or more
000A 004Ch	USB0	Frame Number Register	FRMNUM	16	16	9 PCLKB or more
000A 0054h	USB0	USB Request Type Register	USBREQ	16	16	9 PCLKB or more
000A 0056h	USB0	USB Request Value Register	USBVAL	16	16	9 PCLKB or more
000A 0058h	USB0	USB Request Index Register	USBINDX	16	16	9 PCLKB or more
000A 005Ah	USB0	USB Request Length Register	USBLENG	16	16	9 PCLKB or more
000A 005Ch	USB0	DCP Configuration Register	DCPCFG	16	16	9 PCLKB or more
000A 005Eh	USB0	DCP Maximum Packet Size Register	DCPMAXP	16	16	9 PCLKB or more
000A 0060h	USB0	DCP Control Register	DCPCTR	16	16	9 PCLKB or more
000A 0064h	USB0	Pipe Window Select Register	PIPESEL	16	16	9 PCLKB or more
000A 0068h	USB0	Pipe Configuration Register	PIPECFG	16	16	9 PCLKB or more
000A 006Ch	USB0	Pipe Maximum Packet Size Register	PIPEMAXP	16	16	9 PCLKB or more
000A 006Eh	USB0	Pipe Cycle Control Register	PIPEPERI	16	16	9 PCLKB or more
000A 0070h	USB0	PIPE1 Control Register	PIPE1CTR	16	16	9 PCLKB or more
000A 0072h	USB0	PIPE2 Control Register	PIPE2CTR	16	16	9 PCLKB or more
000A 0074h	USB0	PIPE3 Control Register	PIPE3CTR	16	16	9 PCLKB or more
000A 0076h	USB0	PIPE4 Control Register	PIPE4CTR	16	16	9 PCLKB or more
000A 0078h	USB0	PIPE5 Control Register	PIPE5CTR	16	16	9 PCLKB or more
000A 007Ah	USB0	PIPE6 Control Register	PIPE6CTR	16	16	9 PCLKB or more
000A 007Ch	USB0	PIPE7 Control Register	PIPE7CTR	16	16	9 PCLKB or more
000A 007Eh	USB0	PIPE8 Control Register	PIPE8CTR	16	16	9 PCLKB or more
000A 0080h	USB0	PIPE9 Control Register	PIPE9CTR	16	16	9 PCLKB or more
000A 0090h	USB0	PIPE1 Transaction Counter Enable Register	PIPE1TRE	16	16	9 PCLKB or more
000A 0092h	USB0	PIPE1 Transaction Counter Register	PIPE1TRN	16	16	9 PCLKB or more
000A 0094h	USB0	PIPE2 Transaction Counter Enable Register	PIPE2TRE	16	16	9 PCLKB or more
000A 0096h	USB0	PIPE2 Transaction Counter Register	PIPE2TRN	16	16	9 PCLKB or more
000A 0098h	USB0	PIPE3 Transaction Counter Enable Register	PIPE3TRE	16	16	9 PCLKB or more
000A 009Ah	USB0	PIPE3 Transaction Counter Register	PIPE3TRN	16	16	9 PCLKB or more
000A 009Ch	USB0	PIPE4 Transaction Counter Enable Register	PIPE4TRE	16	16	9 PCLKB or more
000A 009Eh	USB0	PIPE4 Transaction Counter Register	PIPE4TRN	16	16	9 PCLKB or more
000A 00A0h	USB0	PIPE5 Transaction Counter Enable Register	PIPE5TRE	16	16	9 PCLKB or more
000A 00A2h	USB0	PIPE5 Transaction Counter Register	PIPE5TRN	16	16	9 PCLKB or more
000A 00B0h	USB0	BC Control Register 0	USBBCCTRL0	16	16	9 PCLKB or more
000A 00CCh	USB0	USB Module Control Register	USBMC	16	16	9 PCLKB or more
000A 00D0h	USB0	Device Address 0 Configuration Register	DEVADD0	16	16	9 PCLKB or more
000A 00D2h	USB0	Device Address 1 Configuration Register	DEVADD1	16	16	9 PCLKB or more
000A 00D4h	USB0	Device Address 2 Configuration Register	DEVADD2	16	16	9 PCLKB or more
000A 00D6h	USB0	Device Address 3 Configuration Register	DEVADD3	16	16	9 PCLKB or more
000A 00D8h	USB0	Device Address 4 Configuration Register	DEVADD4	16	16	9 PCLKB or more
000A 00DAh	USB0	Device Address 5 Configuration Register	DEVADD5	16	16	9 PCLKB or more
000A 0800h	LCDC	LCD mode register 0	LCDM0	8	8	1 or 2 PCLKB
000A 0801h	LCDC	LCD mode register 1	LCDM1	8	8	1 or 2 PCLKB
000A 0802h	LCDC	LCD Clock Control Register 0	LCDC0	8	8	1 or 2 PCLKB
000A 0803h	LCDC	LCD Boost Level Control Register	VLCD	8	8	1 or 2 PCLKB

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Conditions: VSS = AVSS0 = VREFL0 = VREFL = VSS_USB = 0 V

Item		Symbol	Value	Unit
Power supply voltage		VCC, VCC_USB	–0.3 to +4.6	V
Input voltage	Ports for 5 V tolerant*1	V_{in}	–0.3 to +6.5	V
	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	V_{in}	–0.3 to AVCC0 +0.3	V
	Ports other than above	V_{in}	–0.3 to VCC +0.3	V
Reference power supply voltage		VREFH0	–0.3 to AVCC0 +0.3	V
		VREFH		
Analog power supply voltage		AVCC0	–0.3 to +4.6	V
Analog input voltage		V_{AN}	–0.3 to AVCC0 + 0.3 (when AN000 to AN007 and AN021 used) –0.3 to VCC + 0.3 (when AN008 to AN015 used)	V
LCD voltage	V_{L1} voltage	V_{L1}	–0.3 to +2.8	V
	V_{L2} voltage	V_{L2}	–0.3 to +6.5	
	V_{L3} voltage	V_{L3}	–0.3 to +6.5	
	V_{L4} voltage	V_{L4}	–0.3 to +6.5	
Operating temperature*2		T_{opr}	–40 to +85 –40 to +105	°C
Storage temperature		T_{stg}	–55 to +125	°C

Caution: Permanent damage to the MCU may result if absolute maximum ratings are exceeded.
To preclude any malfunctions due to noise interference, insert capacitors of high frequency characteristics between the VCC and VSS pins, between the AVCC0 and AVSS0 pins, between the VCC_USB and VSS_USB pins, between the VREFH0 and VREFL0 pins, and between the VREFH and VREFL pins. Place capacitors of about 0.1 µF as close as possible to every power supply pin and use the shortest and heaviest possible traces. Also, connect capacitors as stabilization capacitance.

Connect the VCL pin to a VSS pin via a 4.7 µF capacitor. The capacitor must be placed close to the pin, refer to section 5.15.1, Connecting VCL Capacitor and Bypass Capacitors.

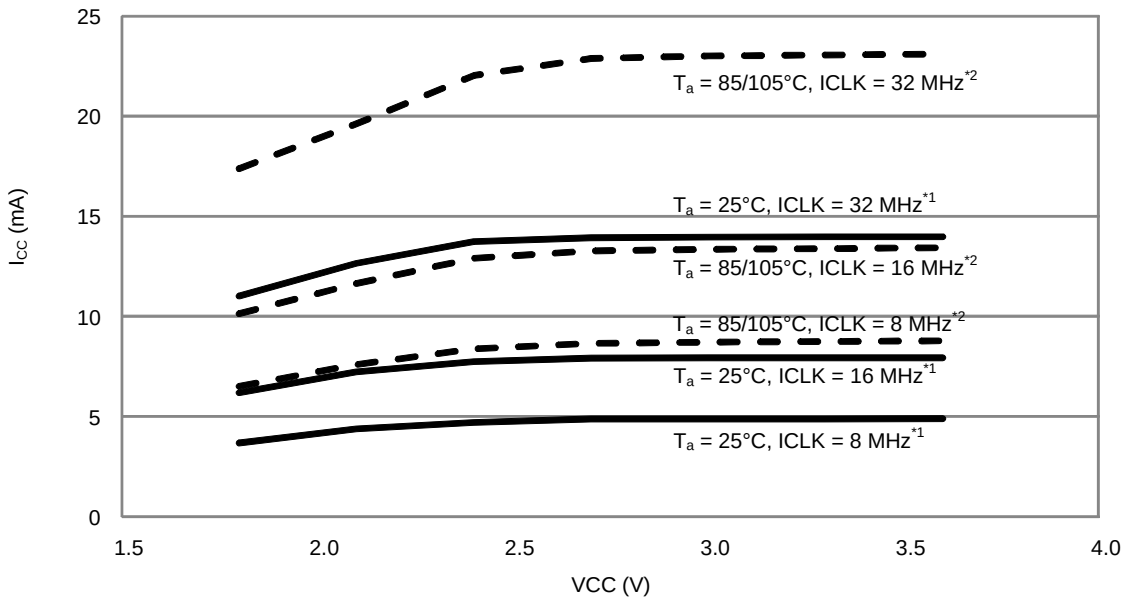
Do not input signals or an I/O pull-up power supply to ports other than 5-V tolerant ports while the device is not powered. The current injection that results from input of such a signal or I/O pull-up may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements.
If input voltage (within the specified range from -0.3 to + 6.5V) is applied to 5-V tolerant ports, it will not cause problems such as damage to the MCU.

Note 1. Ports P16, P17, PA6, and PB0 are 5 V tolerant.
Note 2. The upper limit of operating temperature is 85°C or 105°C, depending on the product. For details, refer to Table 1.3, List of Products.

Table 5.7 DC Characteristics (5) (1/2)

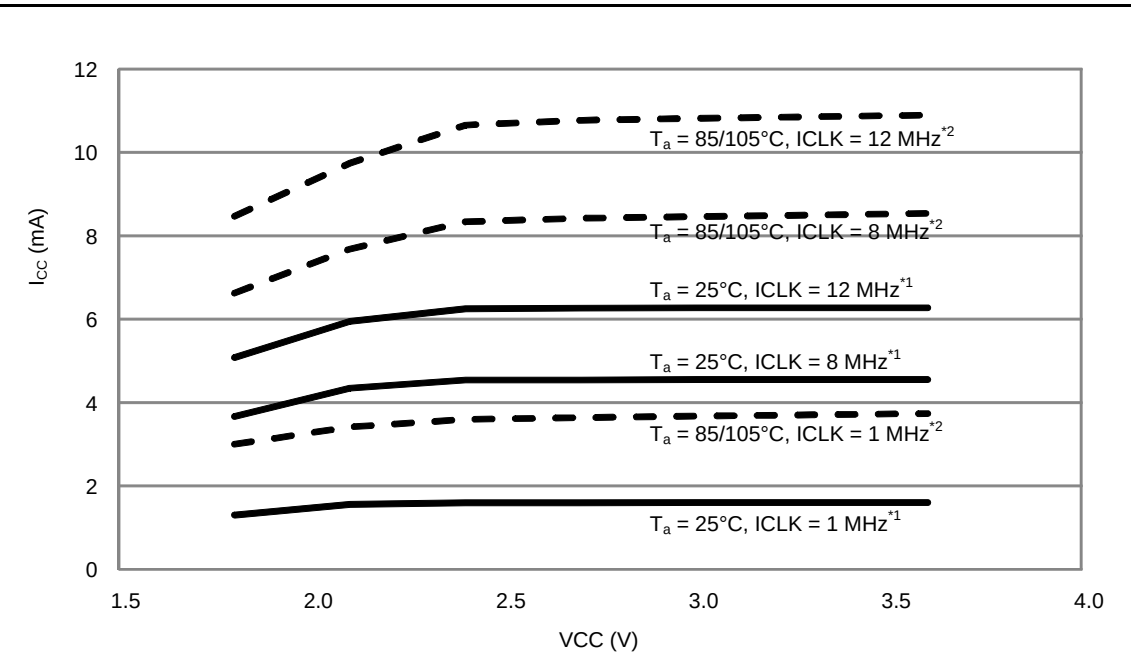
Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item					Symbol	Typ *4	Max	Unit	Test Conditions
Supply current*1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 32 MHz	I_{CC}	3.6	—	mA	
				ICLK = 16 MHz		2.4	—		
				ICLK = 8 MHz		1.8	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		14.0	—		
				ICLK = 16 MHz		7.9	—		
				ICLK = 8 MHz		4.9	—		
			All peripheral operation: Max.*3	ICLK = 32 MHz		—	30.0		
		Sleep mode	No peripheral operation*2	ICLK = 32 MHz		1.9	—		
				ICLK = 16 MHz		1.5	—		
				ICLK = 8 MHz		1.3	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		8.2	—		
				ICLK = 16 MHz		4.8	—		
				ICLK = 8 MHz		3.1	—		
		Deep sleep mode	No peripheral operation*2	ICLK = 32 MHz		1.1	—		
				ICLK = 16 MHz		0.95	—		
				ICLK = 8 MHz		0.86	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		6.4	—		
				ICLK = 16 MHz		3.8	—		
				ICLK = 8 MHz		2.4	—		
		Increase during flash rewrite*5				2.5	—		
	Middle-speed operating modes	Normal operating mode	No peripheral operation*6	ICLK = 12 MHz	I_{CC}	2.1	—	mA	
				ICLK = 8 MHz		1.4	—		
				ICLK = 1 MHz		0.77	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		6.3	—		
				ICLK = 8 MHz		4.6	—		
				ICLK = 1 MHz		1.6	—		
			All peripheral operation: Max.*7	ICLK = 12 MHz		—	14.2		
		Sleep mode	No peripheral operation*6	ICLK = 12 MHz		1.4	—		
				ICLK = 8 MHz		0.90	—		
				ICLK = 1 MHz		0.68	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		3.9	—		
				ICLK = 8 MHz		2.9	—		
				ICLK = 1 MHz		1.4	—		
		Deep sleep mode	No peripheral operation*6	ICLK = 12 MHz		1.1	—		
				ICLK = 8 MHz		0.63	—		
				ICLK = 1 MHz		0.55	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		3.3	—		
				ICLK = 8 MHz		2.4	—		
				ICLK = 1 MHz		1.2	—		
		Increase during flash rewrite*5				2.5	—		



Note 1. All peripheral operation is normal. This does not include BGO operation. Average value of the tested middle samples during product evaluation.
Note 2. All peripheral operation is maximum. This does not include BGO operation. Average value of the tested upper-limit samples during product evaluation.

Figure 5.1 Voltage Dependency in High-Speed Operating Mode (Reference Data)



Note 1. All peripheral operation is normal. This does not include BGO operation. Average value of the tested middle samples during product evaluation.
Note 2. All peripheral operation is maximum. This does not include BGO operation. Average value of the tested upper-limit samples during product evaluation.

Figure 5.2 Voltage Dependency in Middle-Speed Operating Mode (Reference Data)

Table 5.9 DC Characteristics (7)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V

Item	Symbol	Typ.	Max.	Unit	Test Conditions
Permissible total consumption power*1	Pd	—	300	mW	D version (T_a = -40 to 85°C)
		—	105		G version (T_a = -40 to 105°C)*2

Note 1. Total power dissipated by the entire chip (including output currents).
Note 2. Please contact Renesas Electronics sales office for derating under T_a = +85°C to 105°C. Derating is the systematic reduction of load for the sake of improved reliability.

Table 5.10 DC Characteristics (8) (1/2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.*7	Max.	Unit	Test Conditions
Analog power supply current	During A/D conversion (at high-speed conversion)	I_{AVCC}	—	0.7	1.2	mA	
	During D/A conversion (per channel)		—	0.4	0.8		
	Waiting for A/D and D/A conversion (all units)		—	—	0.4	µA	
Reference power supply current	During A/D conversion (at high-speed conversion)	I_{REFH0}	—	25	52	µA	
	Waiting for A/D conversion (all units)		—	—	60	nA	
	During D/A conversion	I_{REFH}	—	50	100	µA	
	Waiting for D/A conversion (all units)		—	—	100	nA	
LDV1, 2	Per channel	I_{LVD}	—	0.15	—	µA	
Temperature sensor*6	—	I_{TEMP}	—	75	—	µA	
Comparator B operating current*6	Window mode	I_{CMP}*4	—	12.5	—	µA	
	Comparator high-speed mode		—	6.5	—	µA	
	Comparator low-speed mode		—	1.7	—	µA	
LCD operating current*6	External resistance division method*8 $f_{LCD} = f_{SUB}$ = 128 Hz, 1/3 bias, and 4-time slice	I_{LCD1}*5	—	0.04	—	µA	
	Internal voltage boosting method (VLCD.VLCD = 04) $f_{LCD} = f_{SUB}$ = 128 Hz, 1/3 bias, and 4-time slice	I_{LCD2}*5	—	0.85	—	µA	
	Internal voltage boosting method (VLCD.VLCD = 12) $f_{LCD} = f_{SUB}$ = 128 Hz, 1/3 bias, and 4-time slice	I_{LCD2}*5	—	1.55	—	µA	
	Capacitor split method $f_{LCD} = f_{SUB}$ = 128 Hz, 1/3 bias, and 4-time slice	I_{LCD3}*5	—	0.20	—	µA	

Table 5.16 Permissible Output Currents (2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V,
T_a = –40 to +105°C (G version)

Item		Symbol	Max.	Unit
Permissible output low current (average value per pin)	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	I_{OL}	0.4	mA
	Ports other than above		8.0	
Permissible output low current (maximum value per pin)	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7		0.4	
	Ports other than above		8.0	
Permissible output low current	Total of ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	ΣI_{OL}	1.6	
	Total of ports P02, P04, P07, P20 to P27, P30, P31, PJ0, PJ2, PJ3		20	
	Total of ports P10 to P17, port P32, ports P50 to P56 ports PB0 to PB7, ports PC0 to PC7		20	
	Total of ports PA0 to PA7, ports PD0 to PD4, ports PE0 to PE7, ports PF6, PF7		20	
	Total of all output pins		40	
Permissible output high current (average value per pin)	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	I_{OH}	–0.1	
	Ports other than above		–4.0	
Permissible output high current (maximum value per pin)	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7		–0.1	
	Ports other than above		–4.0	
Permissible output high current	Total of ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	ΣI_{OH}	–0.6	
	Total of ports P02, P04, P07, P20 to P27, P30, P31, PJ0, PJ2, PJ3		–10	
	Total of ports P10 to P17, port P32, ports P50 to P56, ports PB0 to PB7, ports PC0 to PC7		–15	
	Total of ports PA0 to PA7, ports PD0 to PD4, ports PE0 to PE7, ports PF6, PF7		–15	
	Total of all output pins		–40	

Note: Do not exceed the permissible total supply current.

5.2.1 Standard I/O Pin Output Characteristics (1)

Figure 5.7 to Figure 5.10 show the characteristics of general ports (except for the RIIC output pin, ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7).

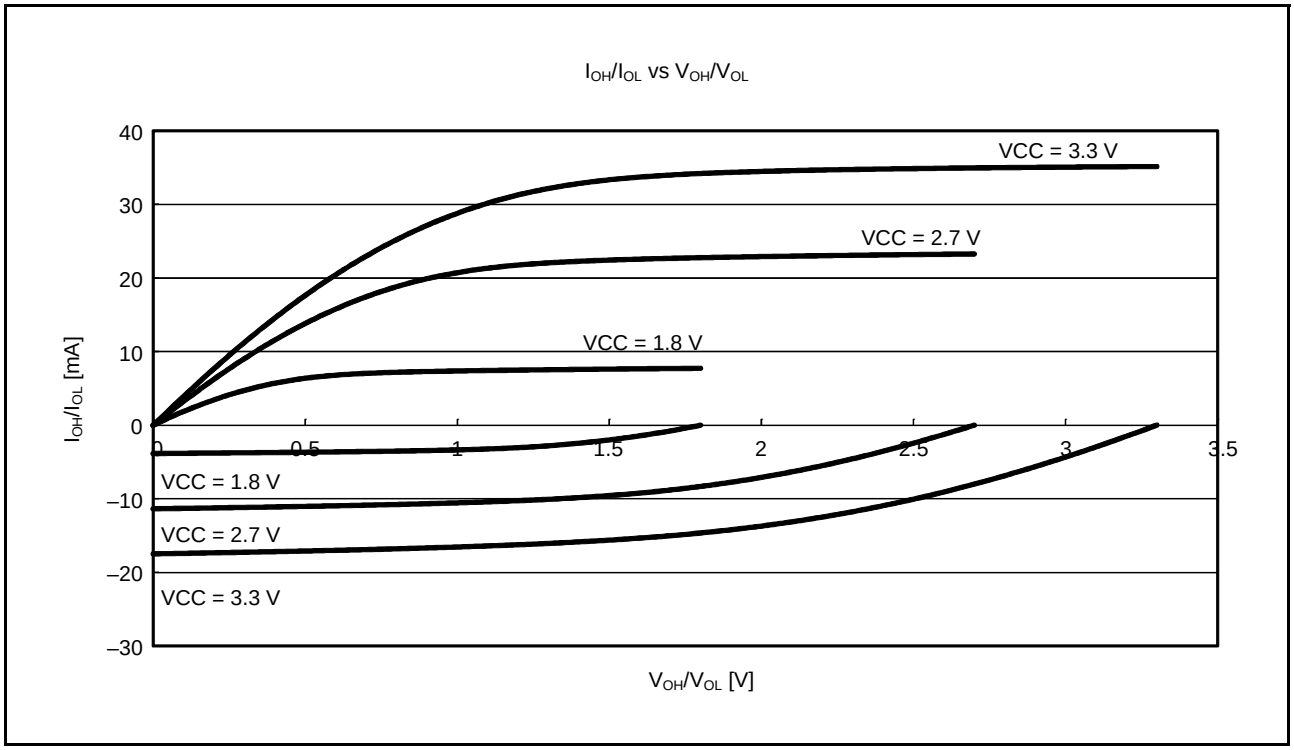


Figure 5.7 V_{OH}/V_{OL} and I_{OH}/I_{OL} Voltage Characteristics of General Ports (Except for RIIC Output Pin, Ports P40 to P44, P46, Ports P90 to P92, Ports PJ6, PJ7) at T_a = 25°C (Reference Data)

5.2.2 Standard I/O Pin Output Characteristics (2)

Figure 5.11 to Figure 5.13 show the characteristics of the RIIC output pin.

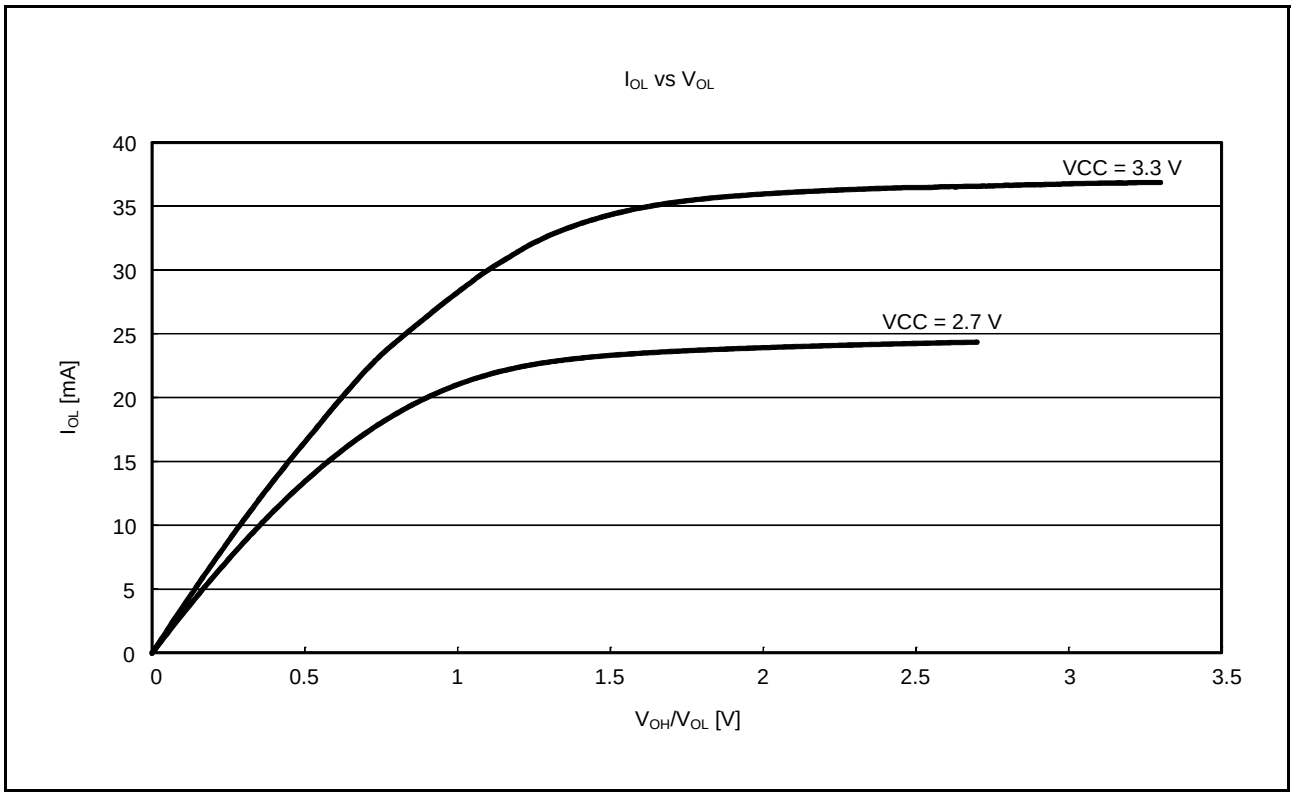


Figure 5.11 V_{OL} and I_{OL} Voltage Characteristics of RIIC Output Pin at T_a = 25°C (Reference Data)

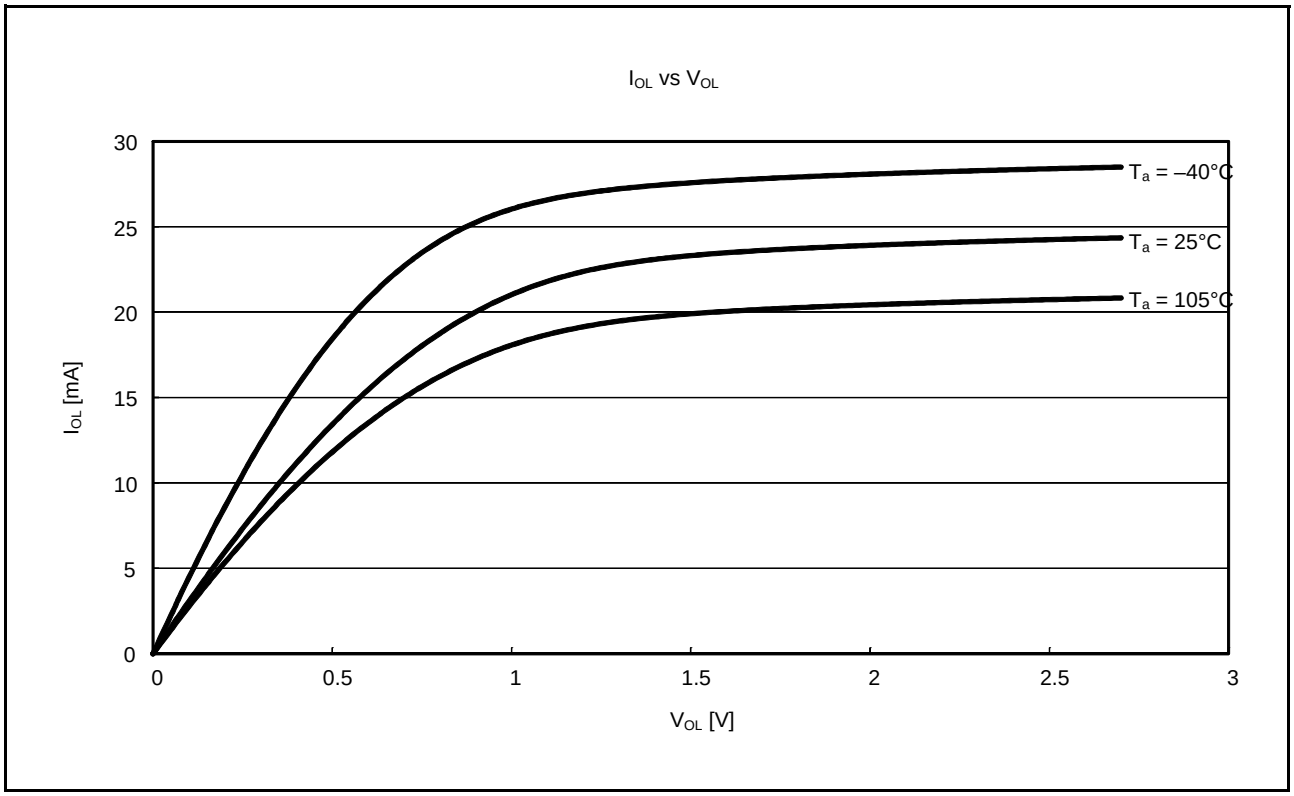


Figure 5.12 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 2.7 V (Reference Data)

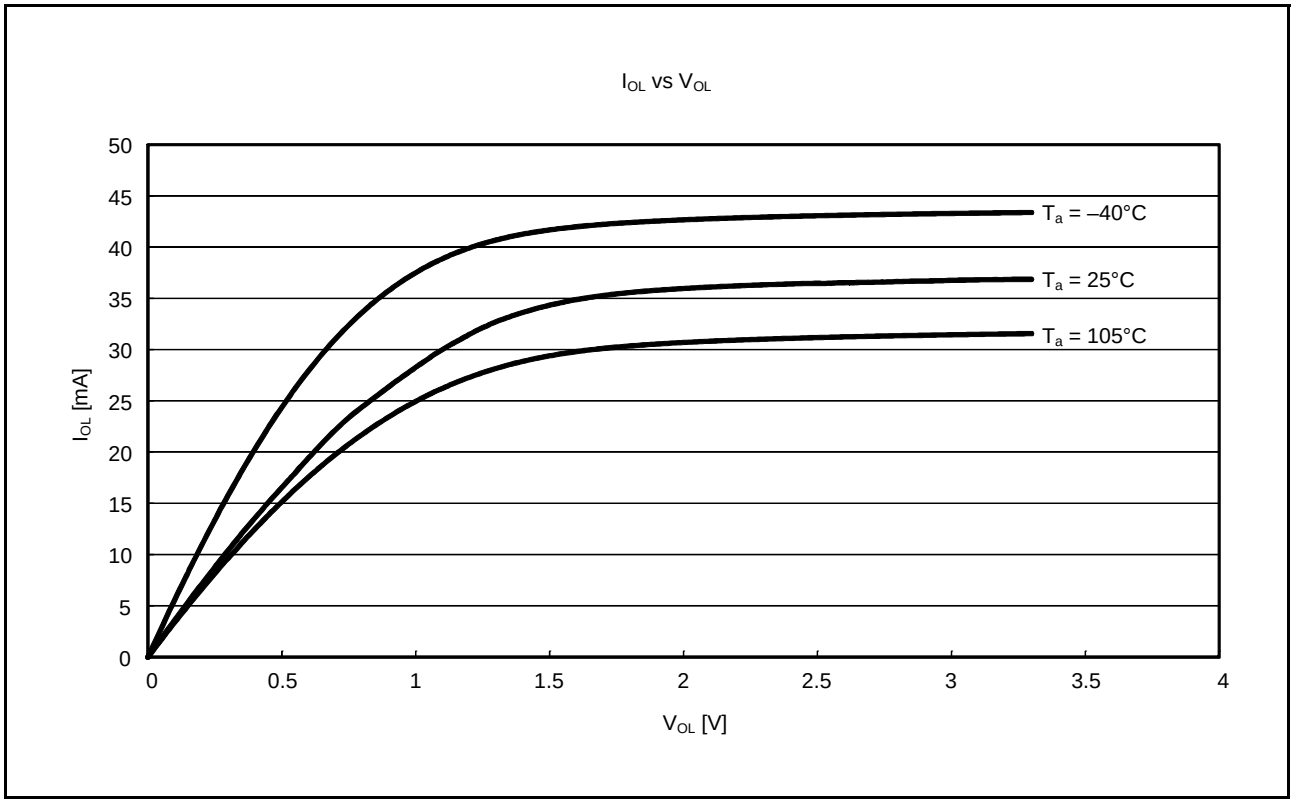


Figure 5.13 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 3.3 V (Reference Data)

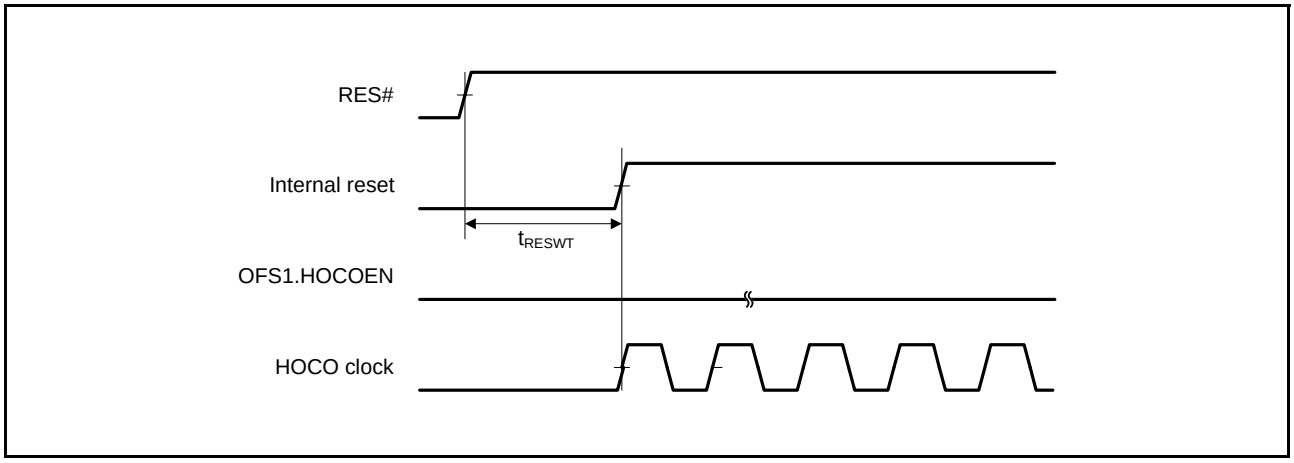


Figure 5.22 HOCO Clock Oscillation Start Timing (After Reset is Canceled by Setting OFS1.HOCOEN Bit to 0)

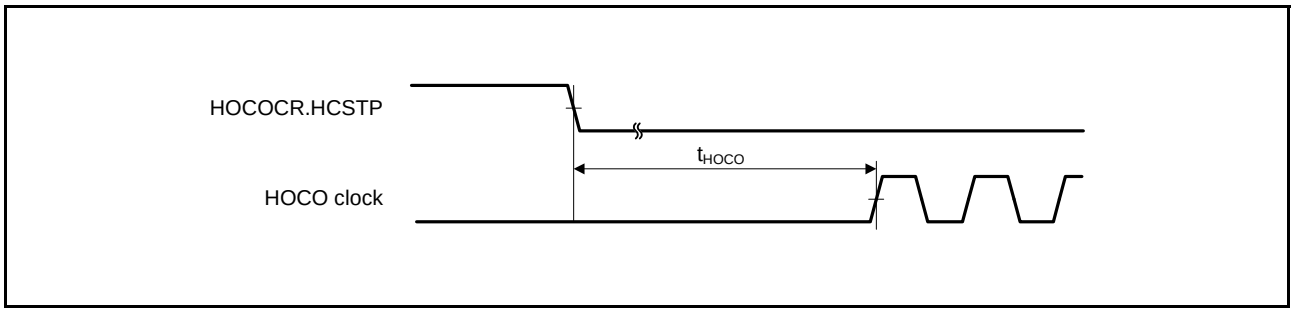


Figure 5.23 HOCO Clock Oscillation Start Timing (Oscillation is Started by Setting HOCOCR.HCSTP Bit)

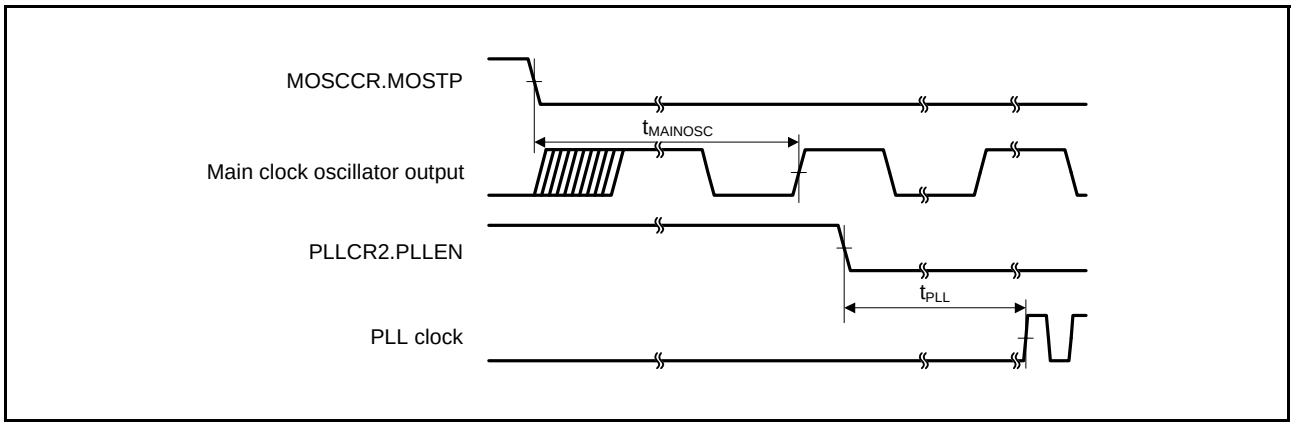


Figure 5.24 PLL Clock Oscillation Start Timing (PLL is Operated after Main Clock Oscillation Has Settled)

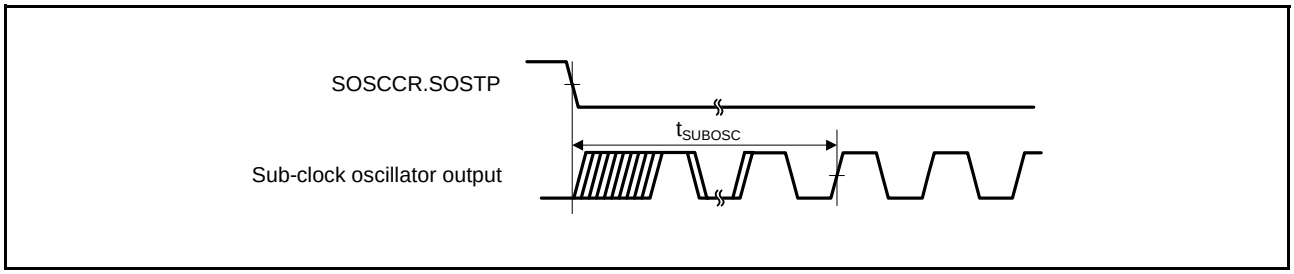


Figure 5.25 Sub-Clock Oscillation Start Timing

Table 5.27 Timing of Recovery from Low Power Consumption Modes (4)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Recovery time from deep sleep mode*1	High-speed mode*2	t_{DSLP}	—	2	3.5	µs	
	Middle-speed mode*3	t_{DSLP}	—	3	4	µs	
	Low-speed mode*4	t_{DSLP}	—	400	500	µs	

Note: When the division ratios of PCLKB, PCLKD, FCLK, and ICLK are all set to 1.
Note 1. Oscillators continue oscillating in deep sleep mode.
Note 2. When the frequency of the system clock is 32 MHz.
Note 3. When the frequency of the system clock is 12 MHz.
Note 4. When the frequency of the system clock is 32.768 kHz.

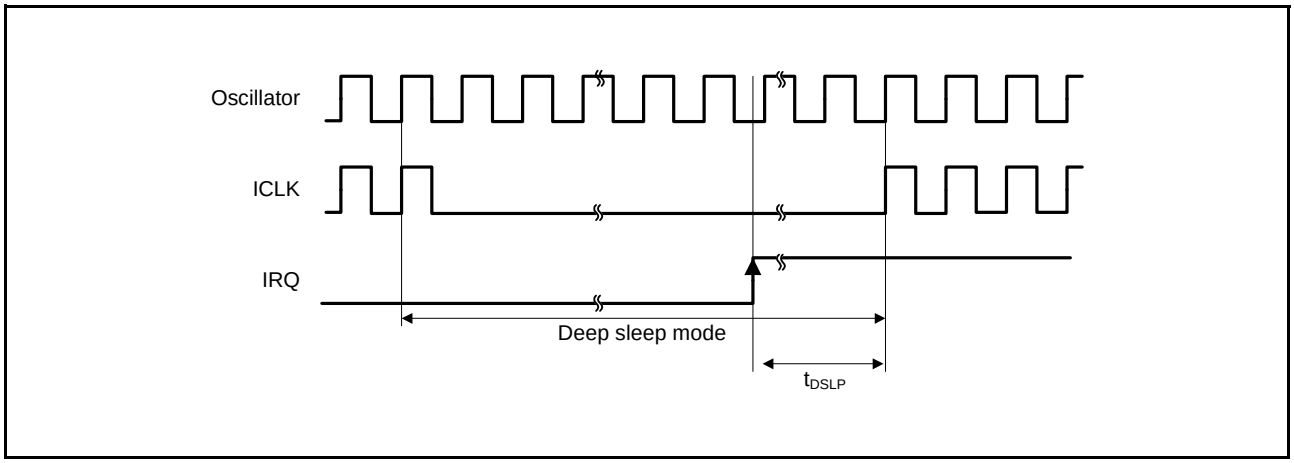


Figure 5.30 Deep Sleep Mode Recovery Timing

Table 5.28 Timing of Recovery from Low Power Consumption Modes (5) Operating Mode Transition Time

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Mode before Transition	Mode after Transition	ICLK Frequency	Transition Time			Unit
			Min.	Typ.	Max.	
High-speed operating mode	Middle-speed operating mode	8 MHz	—	10	—	µs
Middle-speed operating mode	High-speed operating mode	8 MHz	—	37.5	—	µs
Low-speed operating mode	Middle-speed operating mode, high-speed operating mode	32.768 kHz	—	213.62	—	µs
Middle-speed operating mode, high-speed operating mode	Low-speed operating mode	32.768 kHz	—	183.11	—	µs

Note: When the division ratios of PCLKB, PCLKD, FCLK, and ICLK are all set to 1.

Table 5.31 Timing of On-Chip Peripheral Modules (2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V,
T_a = –40 to +105°C, C = 30 pF

Item				Symbol	Min.	Max.	Unit	Test Conditions
RSPI	RSPCK clock cycle	Master		t_{SPcyc}	2	4096	t_{Pcyc}*1	Figure 5.42
		Slave			8	4096		
	RSPCK clock high pulse width	Master		t_{SPCKWH}	$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2$	—		
	RSPCK clock low pulse width	Master		t_{SPCKWL}	$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2$	—		
	RSPCK clock rise/fall time	Output	2.7 V or above	t_{SPCKr}, t_{SPCKf}	—	10	ns	
			1.8 V or above		—	15		
		Input			—	1	µs	
	Data input setup time	Master	2.7 V or above	t_{SU}	10	—	ns	Figure 5.43 to Figure 5.48
			1.8 V or above		30	—		
		Slave			25 – t_{Pcyc}	—		
	Data input hold time	Master	RSPCK set to a division ratio other than PCLKB divided by 2	t_H	t_{Pcyc}	—	ns	
			RSPCK set to PCLKB divided by 2	t_{HF}	0	—		
		Slave		t_H	20 + 2 × t_{Pcyc}	—		
	SSL setup time	Master		t_{LEAD}	–30 + N*2 × t_{SPcyc}	—	ns	
		Slave			2	—	t_{Pcyc}	
	SSL hold time	Master		t_{LAG}	–30 + N*3 × t_{SPcyc}	—	ns	
		Slave			2	—	t_{Pcyc}	
	Data output delay time	Master	2.7 V or above	t_{OD}	—	14	ns	
			1.8 V or above		—	30		
		Slave	2.7 V or above		—	3 × t_{Pcyc} + 65		
			1.8 V or above		—	3 × t_{Pcyc} +105		
	Data output hold time	Master	2.7 V or above	t_{OH}	0	—	ns	
			1.8 V or above		–20	—		
		Slave			0	—		
	Successive transmission delay time	Master		t_{TD}	t_{SPcyc} + 2 × t_{Pcyc}	8 × t_{SPcyc} + 2 × t_{Pcyc}	ns	
		Slave			4 × t_{Pcyc}	—		
	MOSI and MISO rise/ fall time	Output	2.7 V or above	t_{Dr}, t_{Df}	—	10	ns	
			1.8 V or above		—	20		
		Input			—	1	µs	
	SSL rise/fall time	Output		t_{SSLr}, tSSLf	—	20	ns	
		Input			—	1	µs	
	Slave access time		2.7 V or above	t_{SA}	—	6	t_{Pcyc}	Figure 5.47, Figure 5.48
			1.8 V or above		—	7		
	Slave output release time		2.7 V or above	t_{REL}	—	5	t_{Pcyc}	
			1.8 V or above		—	6		

Note 1. t_{Pcyc}: PCLK cycle
Note 2. N: An integer from 1 to 8 that can be set by the RSPI clock delay register (SPCKD)
Note 3. N: An integer from 1 to 8 that can be set by the RSPI slave select negation delay register (SSLND)

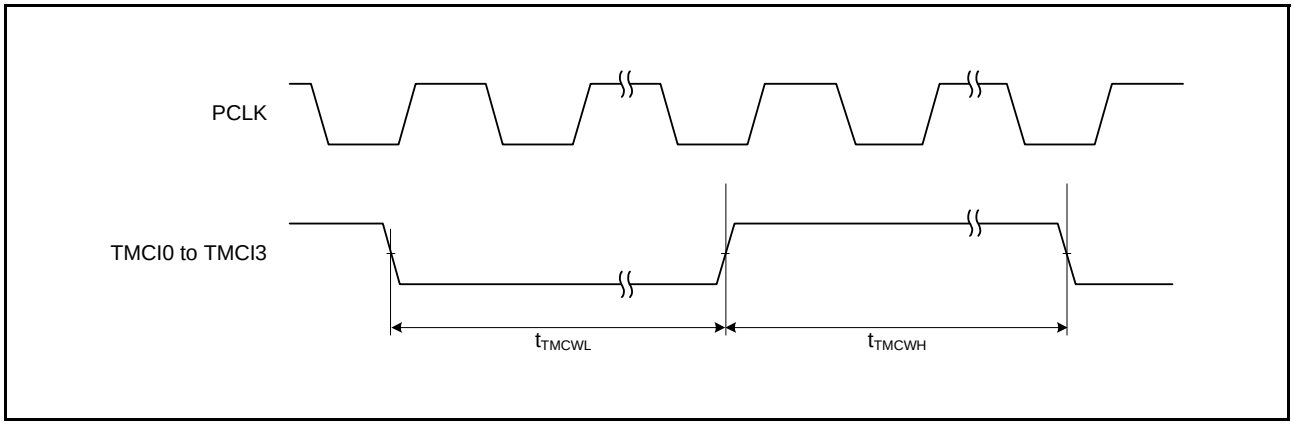


Figure 5.37 TMR Clock Input Timing

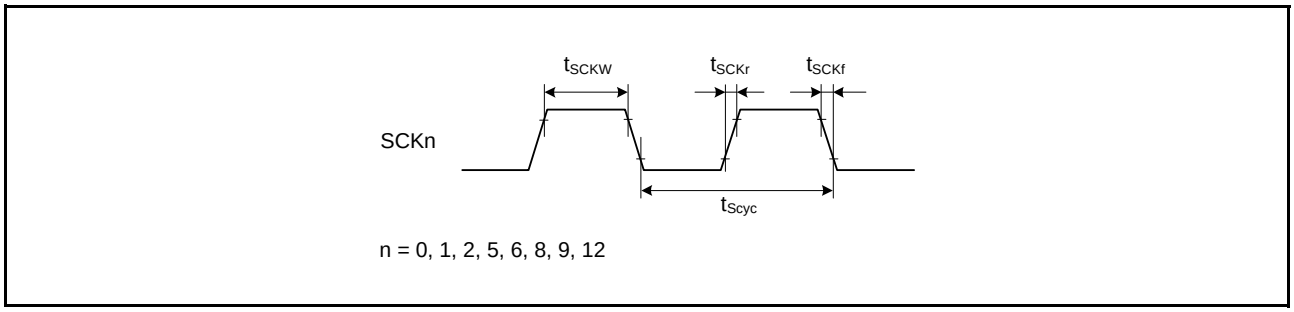


Figure 5.38 SCK Clock Input Timing

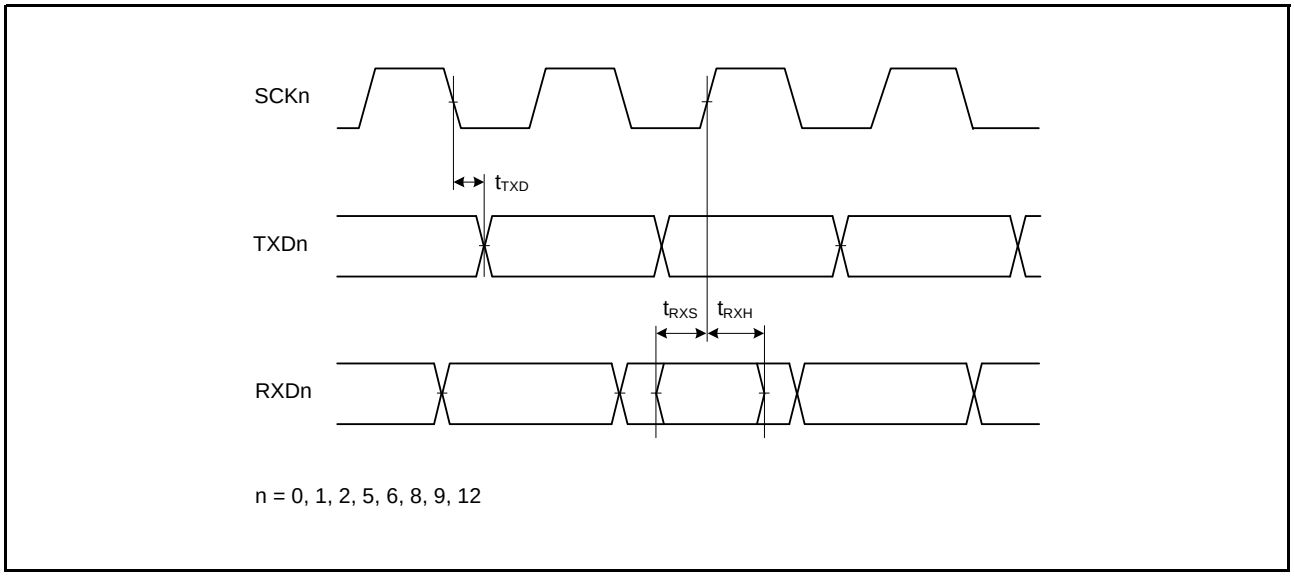


Figure 5.39 SCI Input/Output Timing: Clock Synchronous Mode

5.6 D/A Conversion Characteristics

Table 5.43 D/A Conversion Characteristics (1)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, 1.8 V ≤ VREFH ≤ AVCC0, VSS = AVSS0 = VREFL = VSS_USB = 0 V, T_a = –40 to +105°C
Reference voltage = VREFH and VREFL selected

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	—	—	12	Bit	
Resistive load	30	—	—	kΩ	
Capacitive load	—	—	50	pF	
Output voltage range*1	0.35	—	VREFH	V	VREFH ≤ AVCC0 - 0.47 V
	0.35	—	AVCC0 - 0.47	V	VREFH > AVCC0 - 0.47 V
DNL differential nonlinearity error	—	±0.5	±1.0	LSB	
INL integral nonlinearity error	—	±2.0	±8.0	LSB	
Offset error	—	—	±20	mV	
Full-scale error	—	—	±20	mV	
Output resistance	—	75	—	Ω	
Conversion time	—	—	30	μs	

Note 1. There are restrictions on AVCC0 and VCC depending on the usage conditions for the 12-bit D/A converter and I/O ports. When using ports J0 and J2 as DA0 and DA1 output, make sure that VCC ≥ D/A output voltage.

Table 5.44 D/A Conversion Characteristics (2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 = VREFH ≤ 3.6 V, VSS = AVSS0 = VREFL = VSS_USB = 0 V, T_a = –40 to +105°C
Reference voltage = AVCC0 and AVSS0 selected

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	—	—	12	Bit	
Resistive load	30	—	—	kΩ	
Capacitive load	—	—	50	pF	
Output voltage range*1	0.35	—	AVCC0 - 0.47	V	
DNL differential nonlinearity error	—	±0.5	±2.0	LSB	
INL integral nonlinearity error	—	±2.0	±8.0	LSB	
Offset error	—	—	±30	mV	
Full-scale error	—	—	±30	mV	
Output resistance	—	75	—	Ω	
Conversion time	—	—	30	μs	

Note 1. There are restrictions on AVCC0 and VCC depending on the usage conditions for the 12-bit D/A converter and I/O ports. When using ports J0 and J2 as DA0 and DA1 output, make sure that VCC ≥ D/A output voltage.

(2) 1/4 Bias Method

Table 5.53 Internal Voltage Boosting Method LCD Characteristics

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Conditions		Min.	Typ.	Max.	Unit	Test Conditions
LCD output voltage variation range	V_{L1}	C1 to C4 connected	VLCD = 04h	0.9	1.0	1.08	V	
			VLCD = 05h	0.95	1.05	1.13	V	
			VLCD = 06h	1	1.1	1.18	V	
			VLCD = 07h	1.05	1.15	1.23	V	
			VLCD = 08h	1.1	1.2	1.28	V	
			VLCD = 09h	1.15	1.25	1.33	V	
			VLCD = 0Ah	1.2	1.3	1.38	V	
Doubler output voltage	V_{L2}	C1 to C5 connected		$2V_{L1}$ - 0.08	$2V_{L1}$	$2V_{L1}$	V	
Tripler output voltage	V_{L3}	C1 to C5 connected		$3V_{L1}$ - 0.12	$3V_{L1}$	$3V_{L1}$	V	
Quadruply output voltage	V_{L4}	C1 to C5 connected		$4V_{L1}$ - 0.16	$4V_{L1}$	$4V_{L1}$	V	
Reference voltage setup time*1	t_{VL1S}			5	—	—	ms	
Voltage boost wait time*2	t_{VLWT}	C1 to C5 connected		500	—	—	ms	

Note 1. This is the required wait time from when the reference voltage is specified by the VLCD register (or when the internal voltage boosting method is selected (LCDM0.MDSET1 and MDSET0 = 01b) if the default reference voltage value is used) until voltage boosting starts (VLCON = 1).

Note 2. This is the wait time from when voltage boosting is started (VLCON = 1) until display is enabled (LCDON = 1).